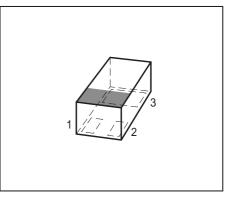


NPN Silicon RF Transistor*

- For low noise, high-gain amplifiers up to 2 GHz
- For linear broadband amplifiers
- $f_{\rm T} = 8 \text{ GHz}, F = 1 \text{ dB at } 900 \text{ MHz}$
- * Short term description



ESD (Electrostatic discharge) sensitive device, observe handling precaution!

Туре	Marking	Pir	n Configura	tion	Package
BFR193L3	RC	1 = B	2 = E	3 = C	TSLP-3-1

Maximum Ratings

Symbol	Value	Unit
V _{CEO}	12	V
V _{CES}	20	
V _{CBO}	20	
V _{EBO}	2	
I _C	80	mA
I _B	10	
P _{tot}	580	mW
T _i	150	°C
T _A	-55 150	
T _{stg}	-55 150	
	$ \begin{array}{c c} \hline V_{CEO} \\ \hline V_{CES} \\ \hline V_{CBO} \\ \hline V_{EBO} \\ \hline I_C \\ \hline I_B \\ \hline P_{tot} \\ \hline T_i \\ \hline T_A \\ \hline \end{array} $	$\begin{array}{c c c c c c c c c c c c c c c c c c c $

Thermal ResistanceParameterSymbolValueUnitJunction - soldering point2) R_{thJS} tbdK/W

 $^{1}\textit{T}_{S}$ is measured on the collector lead at the soldering point to the pcb

²For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Parameter	Symbol	Values			Unit
		min.	typ.	max.]
DC Characteristics					•
Collector-emitter breakdown voltage	V _{(BR)CEO}	12	-	-	V
$I_{\rm C} = 1 {\rm mA}, I_{\rm B} = 0$					
Collector-emitter cutoff current	I _{CES}	-	-	100	μA
$V_{\rm CE} = 20 \text{ V}, \ V_{\rm BE} = 0$					
Collector-base cutoff current	I _{CBO}	-	-	100	nA
$V_{\rm CB} = 10 \text{ V}, I_{\rm E} = 0$					
Emitter-base cutoff current	I _{EBO}	-	-	1	μA
$V_{\rm EB} = 1 \text{V}, I_{\rm C} = 0$					
DC current gain-	h _{FE}	70	100	140	-
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, pulse measured					

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified



Parameter Parameter	Symbol		Unit			
		min.	typ.	max.		
AC Characteristics (verified by random sampling)						
Transition frequency	f _T	6	8	-	GHz	
$I_{\rm C}$ = 50 mA, $V_{\rm CE}$ = 8 V, f = 500 MHz						
Collector-base capacitance	C _{cb}	-	0.63	0.9	pF	
$V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
emitter grounded						
Collector emitter capacitance	C _{ce}	-	0.22	-		
$V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}, V_{BE} = 0$,						
base grounded						
Emitter-base capacitance	C _{eb}	-	2.25	-		
$V_{\rm EB} = 0.5 \text{ V}, f = 1 \text{ MHz}, V_{\rm CB} = 0$,						
collector grounded						
Noise figure	F				dB	
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 900 MHz		-	1	-		
$I_{\rm C}$ = 10 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
<i>f</i> = 1.8 GHz		-	1.6	-		
Power gain, maximum available ¹⁾	G _{ma}					
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 900 \text{ MHz}$		-	19	-		
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm Sopt}$,						
$Z_{\rm L} = Z_{\rm Lopt}$, $f = 1.8 {\rm GHz}$		-	12.5	-		
Transducer gain	S _{21e} ²				dB	
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 900 MHz		-	14.5	-		
$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = 8 V, $Z_{\rm S}$ = $Z_{\rm L}$ = 50 Ω ,						
<i>f</i> = 1.8 GHz		-	9	-		

Electrical Characteristics at $T_A = 25^{\circ}$ C, unless otherwise specified

 ${}^{1}G_{\text{ma}} = |S_{21} / S_{12}| (k \cdot (k^{2} \cdot 1)^{1/2})$

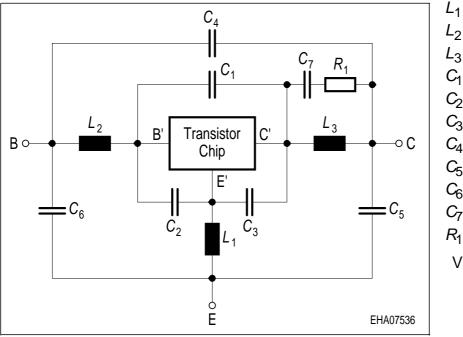


SPICE Parameter (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax):

Transitor Chip Data:								
IS =	0.2738	fA	BF =	125	-	NF =	0.95341	-
VAF =	24	V	IKF =	0.26949	А	ISE =	10.627	fA
NE =	1.935	-	BR =	14.267	-	NR =	1.4289	-
VAR =	3.8742	V	IKR =	0.037925	А	ISC =	0.037409	fA
NC =	0.94371	-	RB =	1.8368	Ω	IRB =	0.91763	mΑ
RBM =	1	Ω	RE =	0.76534	-	RC =	0.11938	Ω
CJE =	1.1824	fF	VJE =	0.70276	V	MJE =	0.48654	-
TF =	18.828	ps	XTF =	0.69477	-	VTF =	0.8	V
ITF =	0.96893	mA	PTF =	0	deg	CJC =	935.03	fF
VJC =	1.1828	V	MJC =	0.30002	-	XCJC =	0.053563	-
TR =	1.0037	ns	CJS =	0	fF	VJS =	0.75	V
MJS =	0	-	NK =	0	-	EG =	1.11	eV
XTI =	3	-	FC =	0.72063		TNOM	300	K

All parameters are ready to use, no scalling is necessary. Extracted on behalf of Infineon Technologies AG by: Institut für Mobil- und Satellitentechnik (IMST)

Package Equivalent Circuit:

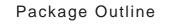


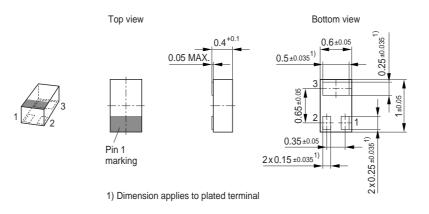
$L_{1} =$	0.575	nH
$L_2 =$	0.575	nH
$L_3 =$	0.275	nH
$C_1 =$	33	fF
$C_2 =$	28	fF
$C_{3}^{-} =$	131	fF
$C_{4} =$	8	fF
C ₅ =	8	fF
$C_{6} =$	24	fF
$C_7 =$	300	fF
R ₁ =	204	Ω

Valid up to 6GHz

For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: http://www.infineon.com/silicondiscretes

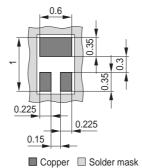


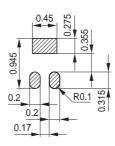




Foot Print

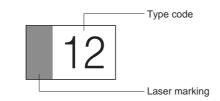
For board assembly information please refer to Infineon website "Packages"

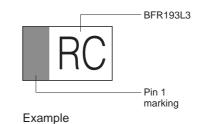




Stencil apertures

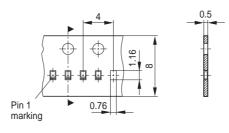
Marking Layout





Standard Packing

Reel ø180 mm = 15.000 Pieces/Reel





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